

IN THE CLAIMS:

Claims 5, 6, 8, 9, 12, 13, and 16 through 19 were previously cancelled. Claims 7 and 14 have been amended herein. All of the pending claims are presented below. This listing of claims will replace all prior versions and listings of claims in the application. Please enter these claims as amended.

1. (Previously presented) A spin coating method, comprising:
applying a material to a substrate;
spinning the substrate and the material at a substantially constant first speed;
following the spinning, decreasing a rate of spinning to a substantially constant second speed;
and
following spinning at the second speed, increasing a rate of the spinning to a substantially constant third speed that is greater than the first speed.
2. (Previously presented) The method of claim 1, wherein spinning the substrate and the material at the first speed comprises substantially filling recesses formed in the substrate with the material.
3. (Previously presented) The method of claim 1, wherein decreasing the rate of spinning to the second speed comprises permitting material located within recesses formed in the substrate to set.
4. (Previously presented) The method of claim 1, wherein spinning the substrate at the third speed comprises forming a layer comprising the material over a surface of the substrate to a desired thickness.
5. (Cancelled)

6. (Cancelled)

7. (Currently amended) A spin coating method, comprising:
applying a material to a substrate;
spinning the substrate and the material at a first speed that permits the material to flow into
recesses formed in the substrate;
spinning the substrate at a second speed that permits the material within the recesses to set,
wherein spinning the substrate at the second speed comprises decreasing a rate at which
the substrate is spun; and
following spinning the substrate at the second speed, increasing a rate of spinning of the substrate
to a third speed that is greater than the first speed ~~wherein spinning the substrate at the~~
~~second speed comprises decreasing a rate at which the substrate is spun.~~

8. (Cancelled)

9. (Cancelled)

10. (Previously presented) The method of claim 7, wherein spinning the substrate and
the material at the first speed comprises substantially filling the recesses with the material.

11. (Previously presented) The method of claim 7, wherein spinning the substrate at
the third speed comprises forming a layer comprising the material over a surface of the substrate
to a desired thickness.

12. (Cancelled)

13. (Cancelled)

14. (Currently amended) A spin coating method, comprising:
applying a material to a substrate;
spinning the substrate at a first speed to at least partially spread the material;
following spinning the substrate at the first speed, spinning the substrate at a second speed to
permit at least some of the material to flow into at least one recess formed in the
substrate, wherein spinning the substrate at the second speed comprises spinning the
substrate at a speed that is slower than the first speed; and
following spinning the substrate at the second speed, increasing a rate of spinning of the substrate
to a third speed that is greater than the first speed ~~wherein spinning the substrate at the
second speed comprises spinning the substrate at a speed that is slower than the first
speed.~~

15. (Previously presented) The method of claim 14, wherein spinning the substrate at
the first speed comprises substantially filling the at least one recess with the material.

16.-19. (Cancelled)

20. (Previously presented) The method of claim 14, wherein spinning the substrate at
the third speed comprises forming a layer comprising the material over a surface of the substrate
to a desired thickness.

21. (Previously presented) The method of claim 1, further comprising:
following gradually increasing, again decreasing a rate of spinning of the substrate to a fourth
speed.

22. (Previously presented) The method of claim 21, comprising permitting the
material to set further while spinning the substrate at the fourth speed.

23. (Previously presented) The method of claim 21, further comprising:
following the again decreasing, again increasing a rate of spinning of the substrate to a fifth
speed.
24. (Previously presented) The method of claim 23, comprising substantially
removing solvent from the material while spinning the substrate at the fifth speed.
25. (Previously presented) The method of claim 7, further comprising:
following gradually increasing, again decreasing a rate of spinning of the substrate to a fourth
speed.
26. (Previously presented) The method of claim 25, comprising permitting the
material to set further while spinning the substrate at the fourth speed.
27. (Previously presented) The method of claim 25, further comprising:
following the again decreasing, again increasing a rate of spinning of the substrate to a fifth
speed.
28. (Previously presented) The method of claim 27, comprising substantially
removing solvent from the material while spinning the substrate at the fifth speed.
29. (Previously presented) The method of claim 14, further comprising:
following gradually increasing, again decreasing a rate of spinning of the substrate to a fourth
speed.
30. (Previously presented) The method of claim 29, comprising permitting the
material to set further while spinning the substrate at the fourth speed.

31. (Previously presented) The method of claim 29, further comprising:
following again decreasing, again increasing a rate of spinning of the substrate to a fifth speed.

32. (Previously presented) The method of claim 31, comprising substantially
removing solvent from the material while spinning the substrate at the fifth speed.